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Investor Contacts:

## NEWS RELEASE

### SMIC Reports 2010 First Quarter Results

*All currency figures stated in this report are in US Dollars unless stated otherwise.  
The financial statement amounts in this report are determined in accordance with US GAAP.*

**Shanghai, China – May 11, 2010.** Semiconductor Manufacturing International Corporation (NYSE: SMI; SEHK: 981) (“SMIC” or the “Company”), one of the leading semiconductor foundries in the world, today announced its consolidated results of operations for the three months ended March 31, 2010.

#### First Quarter 2010 Highlights:

- Revenue exceeded our original guidance and was up by 5.6% to \$351.7 million in 1Q10 from \$333.1 million in 4Q09 and up by 140.1% compared to 1Q09.
- Gross margins improved to 14.6% in 1Q10 compared to 7.6% in 4Q09 primarily due to an increase in wafer shipments and higher ASP.
- Net cash flow from operations has increased to \$153.1 million in 1Q10 from \$89.3 million in 4Q09.
- Loss attributable to holders of ordinary shares narrowed to US\$181.9 million in 1Q10, compared to loss of US\$617.7 million in 4Q09.
- Fully diluted EPS was (\$0.41) per ADS.

#### Second Quarter 2010 Guidance:

The following statements are forward looking statements which are based on current expectation and which involve risks and uncertainties, some of which are set forth under “Safe Harbor Statements” below.

- Revenue is expected to range from 3% to 5% increase.
- Operating expenses excluding foreign exchange differences are expected to range from \$80 million to \$84 million.
- Capital expenditures expected to range from \$150 m



## Conference Call / Webcast Announcement

Date: Wednesday, May 12, 2010

Time: 8:30 a.m. Shanghai time

Dial-in numbers and pass code:

US	1-617-614-3672	(Pass code: SMIC)
HK	852-3002-1672	(Pass code: SMIC)

A live webcast of the 2010 first quarter announcement will be available at <http://www.smics.com> under the "Investor Relations" section, or at

URL: <http://phx.corporate-ir.net/playerlink.zhtml?c=176474&s=wm&e=3029260>.

An archived version of the webcast, along with an electronic copy of this news release will be available on the SMIC website for a period of 12 months following the webcast.



Condition and Results of Operations” sections, and such other documents that SMIC may file with the SEC or SEHK from time to time, including on Form 6-K. Other unknown or unpredictable factors also could have material adverse effects on SMIC’s future results, performance or achievements. In light of these risks, uncertainties, assumptions and factors, the forward-looking events discussed in this press release may not occur. You are cautioned not to place undue reliance on these forward-looking statements, which speak only as of the date stated, or if no date is stated, as of the date of this press release. Except as may be required by law, SMIC undertakes no obligation and does not intend to update any forward-looking statement, whether as a result of new information, future events or otherwise.

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## **Material Litigation**

The Company settled all pending litigation with TSMC on November 9, 2009, including the legal action filed in California for which a verdict was returned by the jury against SMIC on November 4, 2009, with a Settlement Agreement (the “2009 Settlement Agreement”) which replaced the 2005 Settlement Agreement. The 2009 Settlement Agreement resolved all pending lawsuits between the parties and the parties have since dismissed all pending litigation between them. The terms of the 2009 Settlement Agreement include the following:

- 1) Entry of judgment and mutual release of all claims that were or could have been brought in the pending lawsuits;
- 2) Termination of SMIC’s obligation to make remaining payments under the 2005 Settlement Agreement between the parties (approximately US\$40 million);



## Summary of First Quarter 2010 Operating Results

*Amounts in US\$ thousands, except for EPS and operating data*

	1Q10	4Q09	QoQ	1Q09	YoY
Revenue	351,724	333,090	5.6%	146,519	140.1%
Cost of sales	300,270	307,669	-2.4%	275,900	8.8%
Gross profit (loss)	51,454	25,421	102.4%	(129,381)	-
Operating expenses	79,496	622,244	-87.2%	46,681	70.3%
Loss from operations	(28,042)	(596,823)	-95.3%	(176,062)	-84.1%
Other expenses, net	(155,567)	(29,178)	433.2%	(4,480)	3372.5%
Income tax benefit	2,374	8,735	-72.8%	3,305	-28.2%
Net loss after income taxes	(181,235)	(617,266)	-70.6%	(177,238)	2.3%
Loss from equity investment	(455)	(114)	299.1%	(874)	-47.9%
Net loss	(181,690)	(617,380)	-70.6%	(178,111)	2.0%
Accretion of interest to noncontrolling interest	(259)	(274)	-5.5%	(259)	0.0%
Loss attributable to Semiconductor Manufacturing International Corporation	(181,949)	(617,655)	-70.5%	(178,370)	2.0%
Gross margin	14.6%	7.6%		-88.3%	
Operating margin	-8.0%	-179.2%		-120.2%	
Net loss per ordinary share (basic) <sup>(1)</sup>	(0.01)	(0.03)		(0.01)	
Net loss per ADS (basic)	(0.41)	(1.38)		(0.40)	
Net loss per ordinary share					



- Gross margins improved to 14.6% in 1Q10 from 7.6% in 4Q09 primarily due to an increase in wafer shipments and higher ASP.
- Total operating expenses decreased to \$79.5 million in 1Q10 from \$622.2 million in 4Q09, a decrease of 87.2% QoQ primarily due to a decrease in G&A related expenses, larger impairment loss of long-lived assets, and litigation settlement expenses associated with 4Q09.
- R&D expenses decreased to \$43.6 million in 1Q10, down 0.5% QoQ from \$43.8 million in 4Q09.
- G&A expenses decreased to \$17.6 million in 1Q10 from \$151.5 million in 4Q09 due to decreased legal expenses and bad debt expenses.
- Selling & marketing expenses decreased to \$6.0 million in 1Q10, down 22.1% QoQ from \$7.8 million in 4Q09.



## Analysis of Revenues

<b>Sales Analysis</b>			
<b>By Application</b>	<b>1Q10</b>	<b>4Q09</b>	<b>1Q09</b>
Computer	4.3%	6.2%	4.2%
Communications	51.5%	49.0%	50.9%
Consumer	37.0%	38.3%	32.9%
Others	7.2%	6.5%	12.0%
<b>By Service Type</b>	<b>1Q10</b>	<b>4Q09</b>	<b>1Q09</b>
Logic <sup>(1)</sup>	90.3%	90.2%	85.3%
Memory	2.7%	3.4%	2.8%
Mask Making, testing, others	7.0%	6.4%	11.9%
<b>By Customer Type</b>	<b>1Q10</b>	<b>4Q09</b>	<b>1Q09</b>
Fabless semiconductor companies	66.4%	64.4%	70.9%
Integrated device manufacturers (IDM)	17.0%	17.4%	11.4%
System companies and others	16.6%	18.2%	17.7%
<b>By Geography</b>	<b>1Q10</b>	<b>4Q09</b>	<b>1Q09</b>
North America	58.9%	56.4%	60.4%
China <sup>(2)</sup>	24.4%	21.9%	21.4%
Eurasia <sup>(3)</sup>	16.7%	21.7%	18.2%
<b>Wafer Revenue Analysis</b>			
<b>By Technology (logic, memory &amp; copper interconnect only)</b>	<b>1Q10</b>	<b>4Q09</b>	<b>1Q09</b>
0.09 $\mu$ m and below	20.3%	18.7%	8.2%
0.13 $\mu$ m	35.5%	39.5%	30.8%
0.15 $\mu$ m	1.5%	2.7%	0.8%
0.18 $\mu$ m	24.2%	22.9%	31.5%
0.25 $\mu$ m	0.3%	0.3%	0.4%
0.35 $\mu$ m	18.2%	15.9%	28.3%

Note:

(1) Including 0.13 $\mu$ m copper interconnects

(2) Including Hong Kong

(3) Excluding China

- Shipment comprising 0.09 $\mu$ m and below made up 20.3% of overall wafer revenue in 1Q10 as compared to 18.7% in 4Q09.



### Capacity\*

Fab / (Wafer Size)	1Q10	4Q09
Shanghai Mega Fab (8")	84,000	85,000
Beijing Mega Fab (12")	46,800	42,750
Tianjin Fab (8")	34,300	34,300
Total monthly wafer fabrication capacity	165,100	162,050

Note:

\* Wafers per month at the end of the period in 8" equivalent wafers

### Shipment and Utilization

8" equivalent wafers	1Q10	4Q09	1Q09
Wafer shipments including copper interconnects	455,010	436,816	168,743
Utilization rate <sup>(1)</sup>	92.1%	91.5%	34.9%

Note:

(1) Capacity utilization based on total wafer out divided by estimated capacity

- Wafer shipments increased 4.2% QoQ to 455,010 units of 8-inch equivalent wafers in 1Q10 from 436,816 units of 8-inch equivalent wafers in 4Q09, and up 169.6% YoY from 168,743 8-inch equivalent wafers in 1Q09.



## **Detailed Financial Analysis**

### ***Gross Profit Analysis***

<i>Amounts in US\$ thousands</i>	<b>1Q10</b>	<b>4Q09</b>	<b>QoQ</b>	<b>1Q09</b>	<b>YoY</b>
Cost of sales	300,270	307,669	-2.4%	275,900	8.8%
Depreciation	143,919	142,196	1.2%	158,000	-8.9%
Other manufacturing costs	155,119	162,501	-4.5%	111,166	39.5%
Deferred cost amortization	-	1,962	-	5,886	-
Share-based compensation	1,232	1,010	22.0%	848	45.3%
Gross profit (loss)	51,454	25,421	102.4%	(129,381)	-
Gross margin	14.6%	7.6%		-88.3%	

- Cost of sales decreased to \$300.3 million in 1Q10, down 2.4% QoQ from \$307.7 million in 4Q09.
- Gross profit of \$51.5 million in 1Q10, compared to a gross profit of \$25.4 million in 4Q09 and gross loss of \$129.4 million in 1Q09.
- Gross margins improved to 14.6% in 1Q10 from 7.6% in 4Q09 primarily due to an increase in wafer shipments and higher ASP.

### ***Operating Expense Analysis***

<i>Amounts in US\$ thousands</i>	<b>1Q10</b>	<b>4Q09</b>	<b>QoQ</b>	<b>1Q09</b>	<b>YoY</b>
Total operating expenses	79,496	622,244	-87.2%	46,681	70.3%
Research and development	43,592	43,806	-0.5%	18,494	135.7%
General and administrative	17,601	151,520	-88.4%	14,928	17.9%
Selling and marketing	6,045	7,760	-22.1%	4,208	43.7%
Amortization of intangible assets	6,886	7,641	-9.9%	9,031	-23.7%
Loss from disposal of properties	233	3,585	-93.5%	20	1065.0%
Impairment loss of long-lived assets	5,138	138,295	-96.3%	-	-
Litigation settlement	-	269,637			



- Combined with the foreign exchange difference arising from operating activities, the Company recorded an overall foreign exchange loss of \$1.7 million in 1Q10 as compared to a foreign exchange gain of \$3.1 million in 4Q09.
- Other non-operating expenses in 1Q10 included a change in the fair value of the commitment to grant shares and warrants in connection with the



### **Capital Structure**

<i>Amounts in US\$ thousands</i>	<b>1Q10</b>	<b>4Q09</b>
Cash and cash equivalents	523,208	443,463
Restricted cash	29,286	20,360
Current portion of promissory note	59,163	78,608
Promissory note	83,913	83,325
Short-term borrowings	333,795	286,864
Current portion of long-term debt	204,442	205,784
Long-term debt	515,876	550,653
Total debt	1,054,113	1,043,301
Shareholders' equity	1,618,038	1,796,240
Total debt to equity ratio	65.1%	58.1%

### **Cash Flow**

<i>Amounts in US\$ thousands</i>	<b>1Q10</b>	<b>4Q09</b>
Net cash from operating activities	153,094	89,297
Net cash from investing activities	(64,323)	(37,804)
Net cash from financing activities	(8,762)	(60,937)
Net change in cash	79,745	(9,822)

### **Capex Summary**

- Capital expenditures for 1Q10 were \$64 million.



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## **Recent Highlights and Announcements**

- 2009 Annual Report (2010-04-29)
- Circular - (1) Notice of AGM (2) Re-Election of Directors (3) Proposed General Mandates to Issue and Repurchase Shares (4) Proposed Special Mandate for Increasing The Limit On The Grant Of Equity Awards under The 2004 Equity Incentive Plan (5) Proposed Amendments To The 2004 Equity Incentive Plan (2010-04-29)
- Notification Letter and Change Request Form (2010-04-29)
- Notice of Annual General Meeting (2010-04-29)
- Notification of Board Meeting (2010-04-28)
- Announcement of 2009 Annual Results (2010-04-26)
- SMIC Issues Updates on First Quarter 2010 Financial Results and 2009 Annual Results (2010-04-19)
- Notification of Approval of the publication of 2009 Annual Results by the Board (2010-04-13)
- Price Sensitive Information - SMIC 45LL Technology Has Successfully Completed Process Qualification and SRAM Product Qualification (2010-03-30)
- Grant of Option (2010-02-24)
- GalaxyCore Announces New Milestone: Shipment Of 100K 8" Wafers Using SMIC's CMOS Image Sensor Process (2010-02-12)
- Clarification Announcement (2010-02-09)
- SMIC Reports Results For The Three Months Ended December 31, 2009 (2010-02-09)
- Appointment of Chief Business Officer, Chief Operating Officer and Chief Financial Officer (2010-02-09)
- SMIC And SHHIC In Commercial Production Of 0.162um Embedded EEPROM (2010-02-02)
- Notification of Board Meeting (2010-01-25)

*Please visit SMIC's website at [http://www.smics.com/website/enVersion/Press\\_Center/newsRelease.ftl](http://www.smics.com/website/enVersion/Press_Center/newsRelease.ftl) for further details regarding the recent announcements.*



Semiconductor Manufacturing International Corporation  
**CONSOLIDATED BALANCE SHEET**  
(In US dollars, except share data)

	As of	
	March 31, 2010 (Unaudited)	December 31, 2009 (Unaudited)
<b>ASSETS</b>		
Current assets:		
Cash and cash equivalents	523,207,927	443,462,514
Restricted cash	29,286,422	20,360,185
Accounts receivable, net of allowances of \$96,111,136 and \$96,144,543 at March 31, 2010 and December 31, 2009, respectively	204,982,678	204,290,545
Inventories	194,604,324	193,705,195
Prepaid expense and other current assets	32,269,099	28,881,867
Assets held for sale	13,244,958	8,184,462
Current portion of deferred tax assets	8,173,216	8,173,216
<b>Total current assets</b>	<b>1,005,768,624</b>	<b>907,057,984</b>
Prepaid land use rights	77,550,315	78,111,788
Plant and equipment, net	2,129,575,807	2,251,614,217
Acquired intangible assets, net	177,109,741	182,694,105
Equity investment	9,392,886	9,848,148
Other long-term prepayments	214,588	391,741
Deferred tax assets	98,651,547	94,358,635
<b>TOTAL ASSETS</b>	<b>3,498,263,508</b>	<b>3,524,076,618</b>
<b>LIABILITIES AND STOCKHOLDERS' EQUITY</b>		
Current liabilities:		
Accounts payable	237,075,087	228,882,804
Accrued expenses and other current liabilities	116,494,349	111,086,991
Short-term borrowings	333,794,887	286,864,063
Current portion of promissory notes	59,163,022	78,608,288
Current portion of long-term debt	204,442,433	205,784,080
Commitment to issue shares and warrants relating to litigation settlement	266,798,990	120,237,773
Income tax payable	81,310	58,573
<b>Total current liabilities</b>	<b>1,217,850,078</b>	<b>1,031,522,572</b>
Long-term liabilities:		
Non-current portion of promissory notes	83,912,660	83,324,641
Long-term debt	515,875,782	550,653,099
Long-term payables relating to license agreements	4,837,526	4,779,562
Other long-term liabilities	21,647,675	21,679,690
Deferred tax liabilities	1,001,293	1,035,164
<b>Total long-term liabilities</b>	<b>627,274,936</b>	<b>661,472,156</b>
<b>Total liabilities</b>	<b>1,845,125,014</b>	<b>1,692,994,728</b>
Noncontrolling interest	35,100,411	34,841,507
Stockholders' equity:		
Ordinary shares, \$0.0004 par value, 50,000,000,000 shares authorized, 22,420,895,812 and 22,375,886,604 shares issued and outstanding at March 31, 2010 and December 31, 2009, respectively	8,968,359	8,950,355



Semiconductor Manufacturing International Corporation  
CONSOLIDATED BALANCE SHEET  
(In US dollars, except share data)

Additional paid-in capital	3,503,714,048	3,499,723,153
Accumulated other comprehensive loss	(648,316)	(386,163)
Accumulated deficit	(1,893,996,008)	(1,712,046,962)
Total stockholders' equity	<b>1,618,038,083</b>	<b>1,796,240,383</b>
TOTAL LIABILITIES, NONCONTROLLING INTEREST AND STOCKHOLDERS' EQUITY	<b>3,498,263,508</b>	<b>3,524,076,618</b>





Semiconductor Manufacturing International Corporation  
CONSOLIDATED STATEMENT OF CASH FLOWS  
(In US dollars)

For the three months ended

	<u>March 31, 2010</u> <u>(Unaudited)</u>	<u>December 31, 2009</u> <u>(Unaudited)</u>
<b>Operating activities</b>		
Net loss	(181,690,142)	(617,380,324)
<b>Adjustments to reconcile net loss to net cash provided by operating activities:</b>		
Deferred tax	(4,326,783)	(8,786,497)
Loss from sale of equipment and other fixed assets	233,053	3,585



Semiconductor Manufacturing International Corporation  
CONSOLIDATED STATEMENT OF CASH FLOWS  
(In US dollars)

Repayment of promissory notes	(20,000,000)	-
Proceeds from exercise of employee stock options	425,392	96,012
<b>Net cash used in financing activities</b>	<b>(8,762,747)</b>	<b>(60,937,139)</b>